

REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	Add lead finish E device. Under paragraph 1.2.2, make correction to number of pins from 10 to 48. Under Table I, Double ended output parameter, make correction to fout by deleting 5.04 MHz and replacing with 5.00 MHz in both places. Under FIGURE 2 terminal connections, make correction to terminal number 34 by deleting IOG and replacing with IOR. - ro	18-02-09	C. SAFFLE
B	The -01XB device is no longer available. Update JEDEC package from MO-220-WKKD to MO-220-WKKD-4 along with dimensions A2, D/E, D1/E1, and L2 under Figure 1. Add conditions to Input current test as specified under Table I. Make changes to Analog supply current test conditions column for RSET limits as specified under Table I. Under the Figure 3, Mnemonic column; delete IN1 and replace with "G0 to G9", delete D1 and replace with "B0 to B9", delete S1 and replace with "R0 to R9". Update document paragraphs to current requirements. - ro	20-09-16	J. ESCHMEYER



Prepared in accordance with ASME Y14.24

Vendor item drawing

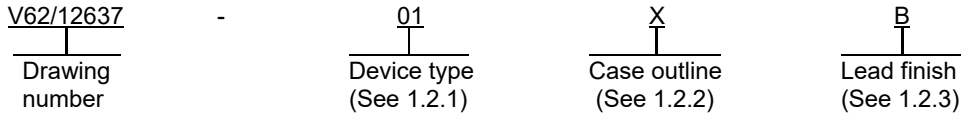
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REV STATUS OF PAGES	REV	B	B	B	B	B	B	B	B	B	B	B	B	B	B					
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PMIC N/A	PREPARED BY Phu H. Nguyen								DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 https://www.dla.mil/LandandMaritime											
Original date of drawing YY-MM-DD 12-10-23	CHECKED BY Phu H. Nguyen								TITLE MICROCIRCUIT, DIGITAL-LINEAR, CMOS, 170 MHZ, TRIPLE, 10-BIT HIGH SPEED VIDEO DAC, MONOLITHIC SILICON											
	APPROVED BY Thomas M. Hess																			
	SIZE A	CODE IDENT. NO. 16236							DWG NO. V62/12637											
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1. SCOPE

1.1 Scope. This drawing documents the general requirements of a high performance CMOS, 170 MHz, triple, 10-bit high speed video digital to analog converter (DAC), microcircuit, with an operating temperature range of -55°C to +105°C.

1.2 Vendor Item Drawing Administrative Control Number. The manufacturer's PIN is the item of identification. The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation:



1.2.1 Device type(s).

<u>Device type</u>	<u>Generic</u>	<u>Circuit function</u>
01	ADV7123-EP	CMOS, 170 MHz, triple, 10-bit high speed video DAC

1.2.2 Case outline(s). The case outline(s) are as specified herein.

<u>Outline letter</u>	<u>Number of pins</u>	<u>JEDEC PUB 95</u>	<u>Package style</u>
X	48	JEDEC MO-220-WKKD-4	Lead frame chip scale package

1.2.3 Lead finishes. The lead finishes are as specified below or other lead finishes as provided by the device manufacturer:

<u>Finish designator</u>	<u>Material</u>
A	Hot solder dip
B	Tin-lead plate
C	Gold plate
D	Palladium
E	Gold flash palladium
F	Tin-lead alloy (BGA/CGA)
Z	Other

1.3 Absolute maximum ratings. 1/ 2/

VAA to GND	+7.0 V
Voltage on any digital pin	GND – 0.5 V to VAA + 0.5 V
IOUT to GND	0 V to VAA 2/
Storage temperature (TS)	-65°C to 150°C
Junction temperature (TJ)	150°C
Lead temperature,(soldering, 10 seconds)	300°C
Vapor phase Soldering (1 minute)	220°C
Ambient operating temperature (TA)	-55°C to +105°C

1/ Stresses beyond those listed under “absolute maximum rating” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2/ Analog outputs short circuit to any power supply or common GND can be of an indefinite duration.

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2. APPLICABLE DOCUMENTS

JEDEC Solid State Technology Association

JEDEC PUB 95 – Registered and Standard Outlines for Semiconductor Devices

(Copies of these documents are available online at <https://www.jedec.org>.)

3. REQUIREMENTS

3.1 Marking. Parts shall be permanently and legibly marked with the manufacturer's part number as shown in 6.3 herein and as follows:

- A. Manufacturer's name, CAGE code, or logo
- B. Pin 1 identifier
- C. ESDS identification (optional)

3.2 Unit container. The unit container shall be marked with the manufacturer's part number and with items A and C (if applicable) above.

3.3 Electrical characteristics. The maximum and recommended operating conditions and electrical performance characteristics are as specified in 1.3, 1.4, and table I herein.

3.4 Design, construction, and physical dimension. The design, construction, and physical dimensions are as specified herein.

3.5 Diagrams.

3.5.1 Case outline. The case outline shall be as shown in 1.2.2 and figure 1.

3.5.2 Terminal connections. The terminal connections shall be as shown in figure 2.

3.5.3 Terminal function. The terminal function shall be as shown in figure 3.

3.5.4 Functional block diagram. The functional block diagram shall be as shown in figure 4.

3.5.5 Timing waveforms and test circuit. The timing waveforms and test circuit shall be as shown in figure 5.

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TABLE I. Electrical performance characteristics. 1/

Test	Symbol	Test conditions 2/	Limits			Unit
			Min	Typ	Max	
Static performance						
Resolution (Each DAC)		RSET = 680 Ω			10	Bits
Integral nonlinearity (BSL)		RSET = 680 Ω	-1	+0.5	+1	LSB
Differential nonlinearity		RSET = 680 Ω	-1	+0.25	+1	LSB
Digital and control inputs						
Input high voltage	V _{IH}		2.0			V
Input low voltage	V _{IL}			0.8		V
Input current	I _{IN}	V _{IN} = 0.0 V or V _{DD}	-1		+1	μA
$\overline{\text{PSAVE}}$ pull up current				20		μA
Input capacitance	C _{IN}			10		pF
Analog outputs						
Output current		Green DAC, $\overline{\text{SYNC}}$ = high	2.0		26.5	mA
		RGB DAC, $\overline{\text{SYNC}}$ = low	2.0		18.5	
DAC to DAC matching				1.0		%
Output compliance Range	V _{OC}		0		1.4	V
Output impedance	R _{OUT}			70		kΩ
Output capacitance	C _{OUT}			10		pF
Offset error		Tested with DAC output = 0 V		0	0	%FSR
Gain error 4/		FSR = 17.62 mA		0		%FSR
Voltage reference, external						
Reference range	V _{REF}		1.12	1.235	1.35	V
Voltage reference, internal						
Reference range	V _{REF}			1.235		V
Power dissipation						
Digital supply current 5/		f _{CLK} = 50 MHz		2.2	5.0	mA
		f _{CLK} = 140 MHz		6.5	12.0	
		f _{CLK} = 517 MHz		7.5	13.5	
Analog supply current		RSET = 560 Ω		67	72	mA
		RSET = 4933 Ω		8		
Standby supply current		$\overline{\text{PSAVE}}$ = low, digital and control inputs at V _{DD}		2.1	5.0	mA
Power supply rejection ratio				0.1	0.5	%/%

See footnote at end of table.

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TABLE I. Electrical performance characteristics - Continued. 1/

Test	Symbol	Test conditions 6/	Limits			Unit
			Min	Typ	Max	
DYNAMIC SPECIFICATIONS						
AC LINEARITY 3/						
Spurious free Dynamic Range to Nyquist 7/						
Single ended output						
fCLK = 50 MHz, fOUT = 1.00 MHz				67		dBc
fCLK = 50 MHz, fOUT = 2.51 MHz				67		
fCLK = 50 MHz, fOUT = 5.04 MHz				63		
fCLK = 50 MHz, fOUT = 20.2 MHz				55		
fCLK = 100 MHz, fOUT = 2.51 MHz				62		
fCLK = 100 MHz, fOUT = 5.04 MHz				60		
fCLK = 100 MHz, fOUT = 20.2 MHz				54		
fCLK = 100 MHz, fOUT = 40.4 MHz				48		
fCLK = 140 MHz, fOUT = 2.51 MHz				57		
fCLK = 140 MHz, fOUT = 5.04 MHz				58		
fCLK = 140 MHz, fOUT = 20.2 MHz				52		
fCLK = 140 MHz, fOUT = 40.4 MHz				41		
Double ended output						
fCLK = 50 MHz, fOUT = 1.00 MHz				70		dBc
fCLK = 50 MHz, fOUT = 2.51 MHz				70		
fCLK = 50 MHz, fOUT = 5.04 MHz				65		
fCLK = 50 MHz, fOUT = 20.2 MHz				54		
fCLK = 100 MHz, fOUT = 2.51 MHz				67		
fCLK = 100 MHz, fOUT = 5.04 MHz				63		
fCLK = 100 MHz, fOUT = 20.2 MHz				58		
fCLK = 100 MHz, fOUT = 40.4 MHz				52		
fCLK = 140 MHz, fOUT = 2.51 MHz				62		
fCLK = 140 MHz, fOUT = 5.04 MHz				61		
fCLK = 140 MHz, fOUT = 20.2 MHz				55		
fCLK = 140 MHz, fOUT = 40.4 MHz				53		

See footnote at end of table.

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TABLE I. Electrical performance characteristics - Continued. 1/

Test	Symbol	Test conditions <u>6/</u>	Limits			Unit
			Min	Typ	Max	
DYNAMIC SPECIFICATIONS – Continued.						
AC LINEARITY – Continued. <u>3/</u>						
Spurious free Dynamic Range within a window						
Single ended output						
fCLK = 50 MHz, fOUT = 1.00 MHz; 1 MHz Span				77		dBc
fCLK = 50 MHz, fOUT = 5.04 MHz; 2 MHz Span				73		
fCLK = 140 MHz, fOUT = 5.04 MHz; 4 MHz Span				64		
Double ended output						
fCLK = 50 MHz, fOUT = 1.00 MHz; 1 MHz Span				74		dBc
fCLK = 50 MHz, fOUT = 5.00 MHz; 2 MHz Span				73		
fCLK = 140 MHz, fOUT = 5.00 MHz; 4 MHz Span				60		
Total harmonic distortion						
fCLK = 50 MHz, fOUT = 1.00 MHz						dBc
TA = 25°C				66		
-55°C ≤ TA ≤ +105°C				65		
fCLK = 50 MHz, fOUT = 2.00 MHz				64		
fCLK = 100 MHz, fOUT = 2.00 MHz				64		
fCLK = 140 MHz, fOUT = 2.00 MHz				55		
DAC performance						
Glitch impulse				10		pV-sec
DAC to DAC crosstalk <u>8/</u>				23		dB
Data feedthrough <u>9/</u> <u>10/</u>				22		dB
Clock feedthrough <u>9/</u> <u>10/</u>				33		dB

See footnote at end of table.

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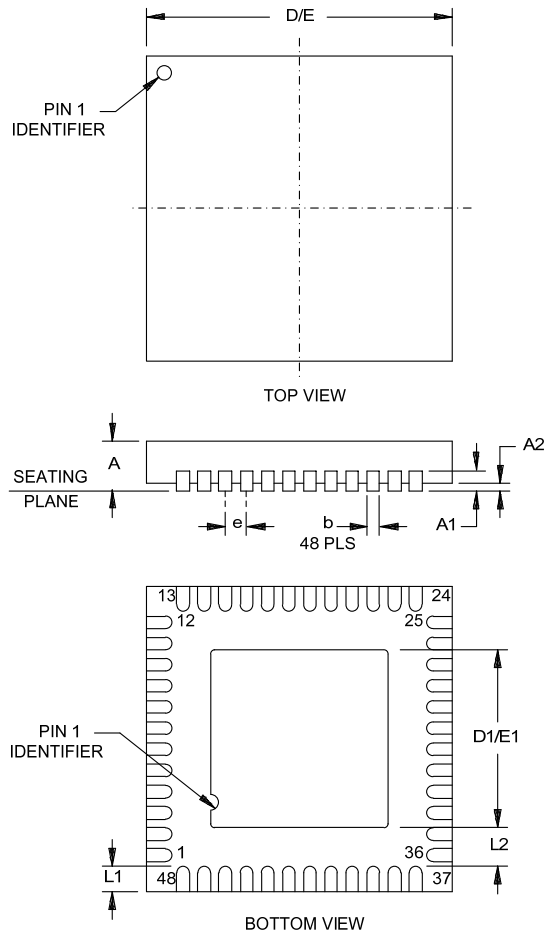
TABLE I. Electrical performance characteristics - Continued. 1/

Test	Symbol	Test conditions <u>2/</u>	Limits			Unit
			Min	Typ	Max	
TIMING SPECIFICATIONS <u>3/</u> <u>11/</u>						
Analog outputs						
Analog output delay	t ₆			7.5		ns
Analog output Rise/Fall time <u>12/</u>	t ₇			1.0		ns
Analog output transition time <u>13/</u>	t ₈			15		ns
Analog output skew <u>14/</u>	t ₉			1	2	ns
Clock control						
Clock frequency <u>15/</u>	fCLK				170	MHz
Data and control setup	t ₁		0.68			ns
Data and control hold	t ₂		2.9			ns
Clock period	t ₃		5.88			ns
Clock pulse width high <u>14/</u>	t ₄	fCLK_MAX = 170 MHz	2.6			ns
Clock pulse width low <u>14/</u>	t ₅	fCLK_MAX = 170 MHz	2.6			ns
Pipeline delay <u>14/</u>	tPD		1.0	1.0	1.0	Clock cycles
$\overline{\text{PSAVE}}$ up time <u>14/</u>	t ₁₀			4	10	ns

- 1/ Testing and other quality control techniques are used to the extent deemed necessary to assure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific parametric testing, product performance is assured by characterization and/or design.
- 2/ V_{AA} = 3.0 V to 3.6 V, V_{REF} = 1.235 V, R_{SET} = 560 Ω, C_L = 10 pF, -55°C ≤ T_A ≤ +105°C, unless otherwise noted; T_J MAX = 110°C.
- 3/ These maximum/minimum specifications are guaranteed by characterization over the 3.0 V to 3.6 V range.
- 4/ Gain error = {Measured (FSC)/Ideal (FSC) – 1} X 100}, where ideal (FSC) = V_{REF}/R_{SET} X K X (0x3FFH) and K = 7.9896.
- 5/ Digital supply is measured with a continuous clock that has data input corresponding to a ramp pattern and with an input level at 0 V and V_{DD}.
- 6/ V_{AA} = 3.0 V to 3.6 V, V_{REF} = 1.235 V, R_{SET} = 680 Ω, C_L = 10 pF. All specifications are at T_A = 25°C, unless otherwise noted; T_J MAX = 110°C.
- 7/ This device exhibits high performance when operating with an internal voltage reference, V_{REF}.
- 8/ DAC to DAC crosstalk measured by holding one DAC high while the other two DACs are making low to high and high to low transactions.
- 9/ Clock and data feedthrough is a function of the amount of overshoot and undershoot on the digital inputs. Glitch impulse includes clock and data feedthrough.
- 10/ TTL input values are 0 V to 3 V, with input rise/fall times of 3 ns, measured at the 10% and 90% points. Timing reference points are 50% for inputs and outputs.
- 11/ Timing specifications are measured with input levels of 3.0 V (V_{IH}) and 0 V (V_{IL}).
- 12/ Rise time was measured from the 10% and 90% point of zero full scale transition, fall time from 90% to 10% point of a full scale transition.
- 13/ Measured from the 50% point of full scale transition to within 2% of the final output value.
- 14/ Guaranteed by characterization.
- 15/ fCLK maximum specification production tested at 125 MHz.

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Case X



Dimensions					
Symbol	Millimeters		Symbol	Millimeters	
	Min	Max		Min	Max
A	0.70	0.80	D1/E1	4.00	4.20
A1	0.20 REF		e	0.50 BSC	
A2	0.02	0.05	L1	0.35	0.45
b	0.18	0.30	L2	0.20	
D/E	6.90	7.10			

NOTES:

1. All linear dimensions are in millimeters.
2. Falls within JEDEC MO-220-WKKD-4.

FIGURE 1. Case outline.

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Case outline X

Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	G0	25	GND
2	G1	26	GND
3	G2	27	$\overline{\text{IOB}}$
4	G3	28	IOB
5	G4	29	V _{AA}
6	G5	30	V _{AA}
7	G6	31	$\overline{\text{IOG}}$
8	G7	32	IOG
9	G8	33	$\overline{\text{IOR}}$
10	G9	34	IOR
11	$\overline{\text{BLANK}}$	35	COMP
12	$\overline{\text{SYNC}}$	36	V _{REF}
13	V _{AA}	37	R _{SET}
14	B0	38	$\overline{\text{PSAVE}}$
15	B1	39	R0
16	B2	40	R1
17	B3	41	R2
18	B4	42	R3
19	B5	43	R4
20	B6	44	R5
21	B7	45	R6
22	B8	46	R7
23	B9	47	R8
24	CLOCK	48	R9

FIGURE 2. Terminal connections.

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Case outline X.

Terminal		Description
Number	Mnemonic	
1 to 10	G0 to G9	Red, Green, and Blue pixel data inputs (TTL compatible). Pixel data is latched on the rising edge of clock. R0, G0, and B0 are the least significant data bits. Unused pixel data inputs should be connected to either the regular printed circuit board (PCB) power or ground plane.
14 to 23	B0 to B9	
39 to 48	R0 to R9	
11	$\overline{\text{BLANK}}$	Composite blank control input (TTL compatible). A logic 0 on this control input drives the analog outputs – IOR, IOB, and IOG – to the blanking level. The $\overline{\text{BLANK}}$ signal is latched on the rising edge of CLOCK. When $\overline{\text{BLANK}}$ is a logic 0, the R0 to R9, G0 to G9, and B0 to B9 pixel inputs are ignored.
12	$\overline{\text{SYNC}}$	Composite sync control input (TTL compatible). A logic 0 on the $\overline{\text{SYNC}}$ input switches off a 40 IRE current source. The sync current is internally connected to the IOG analog output. $\overline{\text{SYNC}}$ does not override any other control or data input; therefore, it should only be asserted during the blanking interval. $\overline{\text{SYNC}}$ is latched on the rising edge of CLOCK. If sync information is not required on the green channel, the $\overline{\text{SYNC}}$ input should be tied to logic 0.
13, 29, 30	VAA	Analog power supply (3.3 V \pm 10%). All VAA pins on this device must be connected.
24	CLOCK	Clock Input (TTL compatible). The rising edge of CLOCK latched at the R0 to R9, G0 to G9, B0 to B9. $\overline{\text{SYNC}}$, and $\overline{\text{BLANK}}$ pixel and control inputs. Typically, the CLOCK input is the pixel clock rate of the video system. CLOCK should be driven by a dedicated TTL buffer.
25, 26	GND	Ground. The GND pins must be connected.
27, 31, 33	$\overline{\text{IOB}}$, $\overline{\text{IOG}}$, $\overline{\text{IOR}}$	Differential Red, Green, and Blue current outputs (High impedance current sources). These RGB video outputs are specified to directly drive RS-343A and RS-170 video levels into a doubly terminated 75 Ω coaxial cable. If the complementary outputs are not required, these outputs should be tie to ground.
28, 32, 34	IOB, IOG, IOR	Red, Green and Blue current outputs (High impedance current sources). These RGB video outputs are specified to directly drive RS-343A and RS-170 video levels into a doubly terminated 75 Ω coaxial cable. All three currents outputs should have similar output loads whether or not they are all being used.
35	COMP	Compensation pin for the internal reference amplifier. A 0.1 μF ceramic capacitor must be connected between COMP and VAA.
36	VREF	Voltage Reference Input for DACs or voltage reference output (1.235 V). The VREF pin is normally terminated to VAA through a 0.1 μF capacitor. However, this device can be overdriven by an external 1.23 V reference (AD1580), if required.
37	R _{SET}	A resistor (R _{SET}) connected between this pin and GND controls the magnitude of the full scale video signal. Note that the IRE relationships are maintained, regardless of the full scale output current. For nominal video levels into a doubly terminated 75 Ω load, R _{SET} = 530 Ω . The relationship between R _{SET} and the full scale output current on IOG (assuming $\overline{\text{SYNC}}$ is connected to IOG) is given by: $\text{RSET } (\Omega) = 11,445 \times \text{VREF (V)} / \text{IOG (mA)}$ The relationship between R _{SET} and the full scale output current on IOR, IOG and IOB is given by: $\text{IOG (mA)} = 11,445 \times \text{VREF (V)} / \text{RSET } (\Omega) \text{ (}\overline{\text{SYNC}} \text{ being asserted)}$ $\text{IOR, IOB (mA)} = 7989.6 \times \text{VREF (V)} / \text{RSET } (\Omega)$ The equation for IOG is the same as that for IOR and IOB when $\overline{\text{SYNC}}$ is not being used, that is, $\overline{\text{SYNC}}$ is tied permanently low.
38	$\overline{\text{PSAVE}}$	Power save control pin. Reduce power consumption is available on this device when this pin is active.
EP	Exposed Pad	The exposed paddle on the underside of the package must be soldered to the ground plane to increase the reliability of the solder joints and to the maximize the thermal capability of the package.

FIGURE 3. Terminal function.

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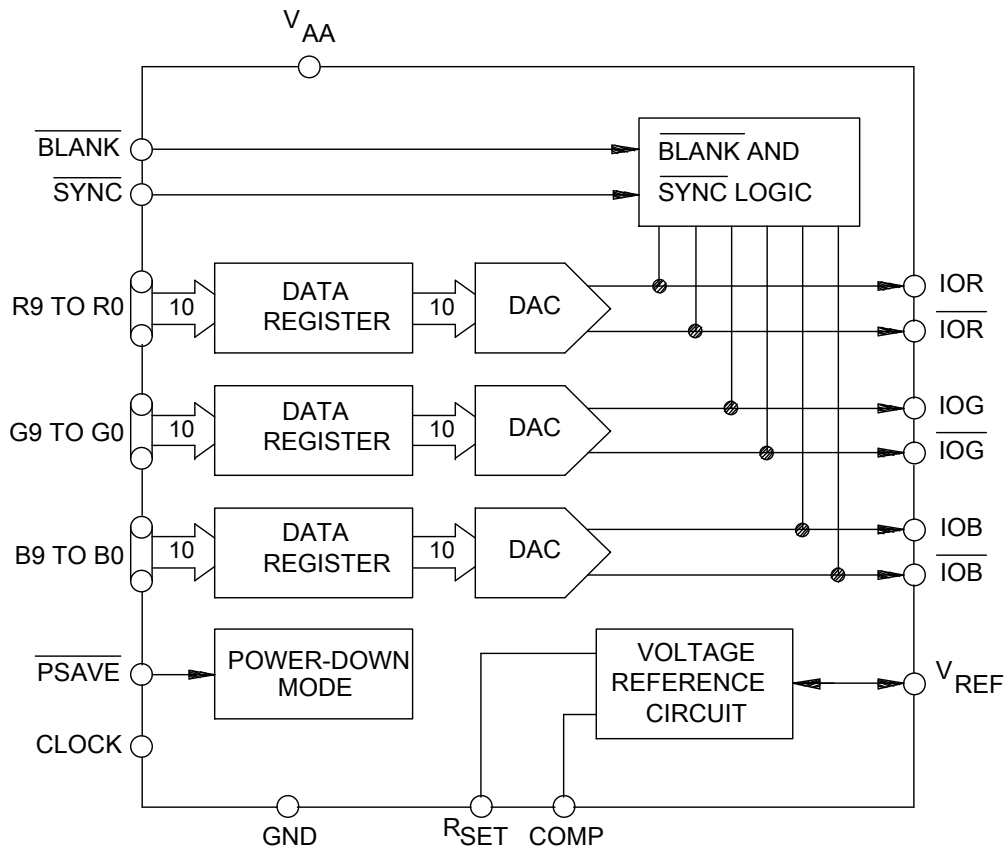
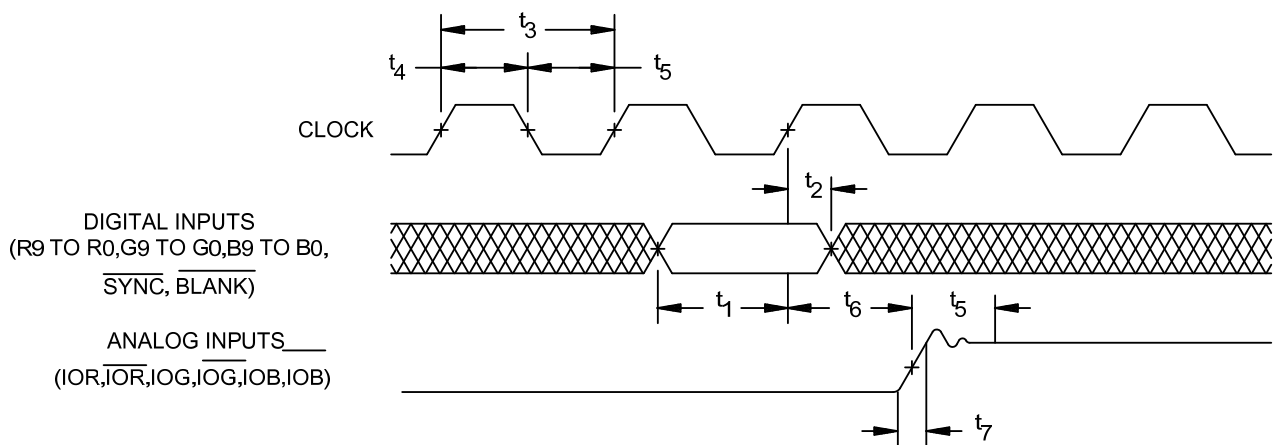


FIGURE 4. Functional block diagram.

<p>DLA LAND AND MARITIME COLUMBUS, OHIO</p>	<p>SIZE A</p>	<p>CODE IDENT NO. 16236</p>	<p>DWG NO. V62/12637</p>
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NOTES:

1. Output delay (t_6) measured from the 50% point of the rising edge of clock to the 50% point of full scale transition.
2. Output Rise/Fall time (t_7) measured between the 10% and 90% points of full scale transition.
3. Transition time (t_8) measured from the 50% point of full scale transition to within 2% of the final output value.

FIGURE 5. Timing diagram.

<p align="center">DLA LAND AND MARITIME COLUMBUS, OHIO</p>	<p align="center">SIZE A</p>	<p align="center">CODE IDENT NO. 16236</p>	<p align="center">DWG NO. V62/12637</p>
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4. VERIFICATION

4.1 Product assurance requirements. The manufacturer is responsible for performing all inspection and test requirements as indicated in their internal documentation. Such procedures should include proper handling of electrostatic sensitive devices, classification, packaging, and labeling of moisture sensitive devices, as applicable.

5. PREPARATION FOR DELIVERY

5.1 Packaging. Preservation, packaging, labeling, and marking shall be in accordance with the manufacturer's standard commercial practices for electrostatic discharge sensitive devices.

6. NOTES

6.1 ESDS. Devices are electrostatic discharge sensitive and are classified as ESDS class 1 minimum.

6.2 Configuration control. The data contained herein is based on the salient characteristics of the device manufacturer's data book. The device manufacturer reserves the right to make changes without notice. This drawing will be modified as changes are provided.

6.3 Suggested source(s) of supply. Identification of the suggested source(s) of supply herein is not to be construed as a guarantee of present or continued availability as a source of supply for the item. DLA Land and Maritime maintains an online database of all current sources of supply at <https://landandmaritimeapps.dla.mil/programs/smcr/>.

Vendor item drawing administrative control number <u>1/</u>	Device manufacturer CAGE code	Vendor part number
V62/12637-01XB	<u>2/</u>	ADV7123SCP170EP-RL
V62/12637-01XE	24355	ADV7123SCP170ZEPRL

- 1/ The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation.
- 2/ Not available from an approved source of supply.

CAGE code

24355

Source of supply

Analog Devices
 Route 1 Industrial Park
 P.O. Box 9106
 Norwood, MA 02062
 Point of contact: 20 Alpha Road
 Chelmsford, MA 01824-4123

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